



Board-to-Board / Wire-to-Board Shielded Horizontal 6 Position Board Mount J Code Automotive HSD Data Connectivity Headers

Part Number:

TE-1-2286550-3







6
HSD Magnetic rect.
1-2286550-3
HSD+2MQS,HDR ASSY,90DEG,COD J
Yes
Board-to-Board Wire-to-Board
2
Horizontal
J
Pin



Mechanical Specification	
Mating Pin Diameter	.6 mm (.02 in)
Centerline (Pitch)	2 mm (.07 in)
Connector Height	8.5 mm (.334 in)
Product Length	15.65 mm (.616 in)
Mating Tab Width	.63 mm (.02 in)
Mating Tab Thickness	.63 mm (.02 in)
PCB Mount Retention Type	Solder Tail

Material Specification		
Contact Mating Plating	Gold (Au)	
Connector Center Contact Plating	Gold (Au)	
Housing Color	Beige	
Body Material	PPA GF25 Zinc Alloy	
Outer Contact Plating	Tin (Sn)	
PCB Retention Plating	Tin	

Electrical Specification	
Connector & Contact Terminates To	Printed Circuit Board
Contact Current Rating (Max) (A)	2.5
Termination Method to PCB	Through Hole - Solder
Mating Retention	With
PCB Mount Retention	With
Operating Voltage (VDC)	60.0
Impedance (Ω)	100.0

Environmental Specification	
Sealable	No

Disclaimer

The information in this specification is subject to change without notice. Please confirm the latest version before use. Technical parameters are for reference only, and sufficient testing and verification should be conducted in actual applications.